Application Form for IC Innovation Acceleration Platform Resource Requirement							
Explanation of the Guidelines:							
1. IC Innovation Acceleration Platform leverages Taiwan's leading semiconductor							
capabilities and abundant resources to consolidate key resources needed for chip							
development, assisting global IC startups in accelerating the realization of potential							
products.							
2. The maximum value of the investment provided is up to USD 3 million.							
3. Equity exchange will generally be conducted using the SAFE (Simple Agreement							
for Future Equity) model. If SAFE is not applicable under the relevant national							
regulations, alternative equity exchange methods will be negotiated.							
Detailed required support: (Please describe the product and required support in detail,							
including product specifications, process nodes, collaboration need with Taiwanese							
manufacturers, etc.)							
☐ Product name and functions diagram:							
Product specifications: (please list details)							
Resource requirements for product development: (multiple answers and							
description accepted)							
☐ EDA tools requirements:							
☐ IP requirements:							
☐ Requirements of IC design service:							
Target of foundry:							
☐ IC Process node: nm							
□ Process Type (GP, BCD, RF, Mixed-Signal…etc.) :							
Special requirements for packaging and testing:							
☐ System integration or EVB requirements:							

	Product schedule:							
	Have you contacted any suppliers from Taiwan? If so, please list them.							
_	Trave you contacted any suppliers from ranwant. It so, prease hist them.							
Other requirements:								
П	Business development requirements:							
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	Fundraising requirements:							
	Company registration in Taiwan:							
☐ Others (please elaborate additional product development requirements, etc.)								
Equity Information								
Equ	Equity structure:							
	Shareholder name		Nationality		Ratio			
Amount and valuation of previous rounds of funding: Amount of Post-money Pos								
	Round	Date		raising	Post-mo Valuat	ion	Paid-in capital	
				SD K)	(USD		(USD K)	
The above information must provide relevant supporting evidence, including								
"shareholder list", " Remittance certificate for fundraising ", and " Paid-in capital ".								
Signature of consent (signature of the company representative or CEO. For								
teams, all team members need to sign):								